



PRELIMINARY

## COP414L/COP314L Single-Chip N-Channel Microcontrollers

### General Description

The COP414L Single-Chip N-Channel Microcontrollers are members of the COPSTM family, fabricated using N-channel, silicon gate MOS technology. This Controller Oriented Processor is a complete microcomputer containing all system timing, internal logic, ROM, RAM and I/O necessary to implement dedicated control functions in a variety of applications. Features include single supply operation, a variety of output configuration options, with an instruction set, internal architecture and I/O scheme designed to facilitate keyboard input, display output and BCD data manipulation. The COP414L is an appropriate choice for use in numerous human interface control environments. Standard test procedures and reliable high-density fabrication techniques provide the medium to large volume customers with a customized Controller Oriented Processor at a low end-product cost.

The COP314L is an exact functional equivalent but extended temperature version of COP414L.

The COP414L can be emulated by the COP404C. The COP401L should be used for exact emulation.

### Features

- Late waferfab programming of ROM and I/O for fast delivery of units
- Low cost
- Powerful instruction set
- 512 x 8 ROM, 32 x 4 RAM
- 15 I/O lines
- Two-level subroutine stack
- 16  $\mu$ s instruction time
- Single supply operation (4.5V–6.3V)
- Low current drain (6 mA max)
- Internal binary counter register with MICROWIRE™ serial I/O capability
- General purpose and TRI-STATE® outputs
- LSTTL/CMOS compatible in and out
- Software/hardware compatible with other members of COP400 family
- Extended temperature range device
  - COP314L (–40°C to +85°C)
- Wider supply range (4.5V–9.5V) optionally available

### Block Diagram

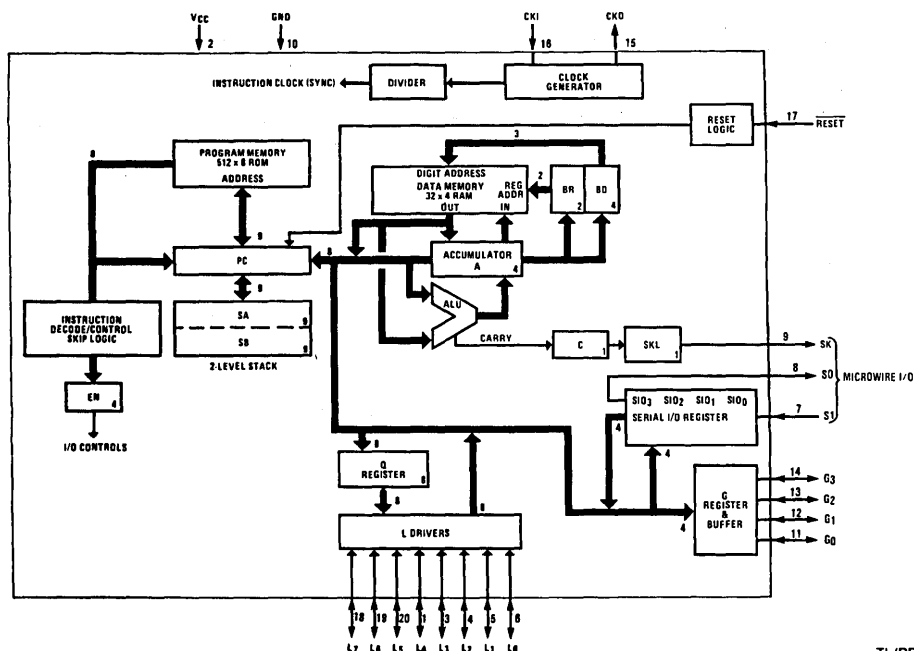


FIGURE 1. COP414L

TL/DD/8814-1

**COP414L****Absolute Maximum Ratings**

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Voltage at Any Pin Relative to GND	-0.5V to +10V
Ambient Operating Temperature	0°C to +70°C
Ambient Storage Temperature	-65°C to +150°C
Lead Temperature (Soldering, 10 sec.)	300°C

Power Dissipation  
COP414L

0.65W at 25°C  
0.3W at 70°C

Total Source Current

120 mA

Total Sink Current

100 mA

Note: Absolute maximum ratings indicate limits beyond which damage to the device may occur. DC and AC electrical specifications are not ensured when operating the device at absolute maximum ratings.

**DC Electrical Characteristics** 0°C ≤ T<sub>A</sub> ≤ +70°C, 4.5V ≤ V<sub>CC</sub> ≤ 9.5V unless otherwise noted

Parameter	Conditions	Min	Max	Units
Standard Operating Voltage (V <sub>CC</sub> )	(Note 1)	4.5	6.3	V
Optional Operating Voltage (V <sub>CC</sub> )		4.5	9.5	V
Power Supply Ripple	Peak to Peak		0.5	V
Operating Supply Current	All Inputs and Outputs Open		6	mA
<b>Input Voltage Levels</b>				
<b>CKI Input Levels</b>				
Ceramic Resonator Input (÷ 8)				
Logic High (V <sub>IH</sub> )	V <sub>CC</sub> = Max	3.0		V
Logic High (V <sub>IH</sub> )	V <sub>CC</sub> = 5V ± 5%	2.0		
Logic Low (V <sub>IL</sub> )		-0.3	0.4	V
<b>Schmitt Trigger Input (÷ 4)</b>				
Logic High (V <sub>IH</sub> )		0.7 V <sub>CC</sub>		V
Logic Low (V <sub>IL</sub> )		-0.3	0.6	V
<b>RESET Input Levels</b>				
	(Schmitt Trigger Input)			
Logic High		0.7 V <sub>CC</sub>		V
Logic Low		-0.3	0.6	V
SO Input Level (Test Mode)	(Note 2)	2.0	2.5	V
<b>All Other Inputs</b>				
Logic High	V <sub>CC</sub> = Max	3.0		V
Logic High	With TTL Trip Level Options	2.0		V
Logic Low	Selected, V <sub>CC</sub> = 5V ± 5%	-0.3	0.8	V
Logic High	With High Trip Level Options	3.6		V
Logic Low	Selected	-0.3	1.2	V
Input Capacitance			7	pF
Hi-Z Input Leakage		-1	+1	μA
<b>Output Voltage Levels</b>				
<b>LSTTL Operation</b>				
Logic High (V <sub>OH</sub> )	V <sub>CC</sub> = 5V ± 10% I <sub>OH</sub> = -25 μA	2.7		V
Logic Low (V <sub>OL</sub> )	I <sub>OL</sub> = 0.36 mA		0.4	V
<b>CMOS Operation</b>				
Logic High	I <sub>OH</sub> = -10 μA	V <sub>CC</sub> - 1		V
Logic Low	I <sub>OL</sub> = +10 μA		0.2	V

Note 1: V<sub>CC</sub> voltage change must be less than 0.5V in a 1 ms period to maintain proper operation.

Note 2: SO output "0" level must be less than 0.8V for normal operation.

**COP414L****DC Electrical Characteristics**  $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$ ,  $4.5\text{V} \leq V_{CC} \leq 9.5\text{V}$  unless otherwise noted (Continued)

Parameter	Conditions	Min	Max	Units
<b>Output Current Levels</b>				
<b>Output Sink Current</b>				
SO and SK Outputs ( $I_{OL}$ )	$V_{CC} = 9.5\text{V}$ , $V_{OL} = 0.4\text{V}$	1.8		mA
	$V_{CC} = 6.3\text{V}$ , $V_{OL} = 0.4\text{V}$	1.2		mA
	$V_{CC} = 4.5\text{V}$ , $V_{OL} = 0.4\text{V}$	0.9		mA
L <sub>0</sub> –L <sub>7</sub> Outputs, G <sub>0</sub> –G <sub>3</sub> and LSTTL D <sub>0</sub> –D <sub>3</sub> Outputs ( $I_{OL}$ )	$V_{CC} = 9.5\text{V}$ , $V_{OL} = 0.4\text{V}$	0.4		mA
	$V_{CC} = 6.3\text{V}$ , $V_{OL} = 0.4\text{V}$	0.4		mA
	$V_{CC} = 4.5\text{V}$ , $V_{OL} = 0.4\text{V}$	0.4		mA
CKI (Single-pin RC Oscillator) CKO	$V_{CC} = 4.5$ , $V_{IH} = 3.5\text{V}$	2		mA
	$V_{CC} = 4.5$ , $V_{OL} = 0.4\text{V}$	0.2		mA
<b>Output Source Current</b>				
Standard Configuration, All Outputs ( $I_{OH}$ )	$V_{CC} = 9.5\text{V}$ , $V_{OH} = 2.0\text{V}$	–140	–800	$\mu\text{A}$
	$V_{CC} = 6.3\text{V}$ , $V_{OH} = 2.0\text{V}$	–75	–480	$\mu\text{A}$
	$V_{CC} = 4.5\text{V}$ , $V_{OH} = 2.0\text{V}$	–30	–250	$\mu\text{A}$
Push-Pull Configuration SO and SK Outputs ( $I_{OH}$ )	$V_{CC} = 9.5\text{V}$ , $V_{OH} = 4.75\text{V}$	–1.4		mA
	$V_{CC} = 6.3\text{V}$ , $V_{OH} = 2.4\text{V}$	–1.4		mA
	$V_{CC} = 4.5\text{V}$ , $V_{OH} = 1.0\text{V}$	–1.2		mA
Input Load Source Current	$V_{CC} = 5.0\text{V}$ , $V_{IL} = 0\text{V}$	–10	–140	$\mu\text{A}$
Open Drain Output Leakage		–2.5	+2.5	$\mu\text{A}$
<b>Total Sink Current Allowed</b>				
All Outputs Combined			100	mA
D Port			100	mA
L <sub>7</sub> –L <sub>4</sub> , G Port			4	mA
L <sub>3</sub> –L <sub>0</sub>			4	mA
Any Other Pin			2.0	mA
<b>Total Source Current Allowed</b>				
All I/O Combined			120	mA
L <sub>7</sub> –L <sub>4</sub>			60	mA
L <sub>3</sub> –L <sub>0</sub>			60	mA
Each L Pin			25	mA
Any Other Pin			1.5	mA

**COP314L****Absolute Maximum Ratings**

Voltage at Any Pin Relative to GND	−0.5V to +10V
Ambient Operating Temperature	−40°C to +85°C
Ambient Storage Temperature	−65°C to +150°C
Lead Temperature (Soldering, 10 seconds)	300°C

Power Dissipation COP314L	0.65W at 25°C 0.20W at 85°C
Total Source Current	120 mA
Total Sink Current	100 mA

Note: *Absolute maximum ratings indicate limits beyond which damage to the device may occur. DC and AC electrical specifications are not ensured when operating the device at absolute maximum ratings.*

**DC Electrical Characteristics**

COP314L:  $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ ,  $4.5\text{V} \leq V_{CC} \leq 7.5\text{V}$  unless otherwise noted

Parameter	Conditions	Min	Max	Units
Standard Operating Voltage ( $V_{CC}$ )	(Note 1)	4.5	5.5	V
Optional Operating Voltage ( $V_{CC}$ )		4.5	7.5	V
Power Supply Ripple	Peak to Peak		0.5	V
Operating Supply Current	All Inputs and Outputs Open		8	mA
Input Voltage Levels				
Ceramic Resonator Input ( $\div 8$ )				
Crystal Input				
Logic High ( $V_{IH}$ )	$V_{CC} = \text{Max}$	3.0		V
Logic High ( $V_{IH}$ )	$V_{CC} = 5\text{V} \pm 5\%$	2.2		V
Logic Low ( $V_{IL}$ )		−0.3	0.3	V
Schmitt Trigger Input ( $\div 4$ )				
Logic High ( $V_{IH}$ )		$0.7 V_{CC}$		V
Logic Low ( $V_{IL}$ )		−0.3	0.4	V
RESET Input Levels	(Schmitt Trigger Input)			
Logic High		$0.7 V_{CC}$		V
Logic Low		−0.3	0.4	V
SO Input Level (Test Mode)	(Note 2)	2.2	2.5	V
All Other Inputs				
Logic High	$V_{CC} = \text{Max}$	3.0		V
Logic High	With TTL Trip Level Options	2.2		V
Logic Low	Selected, $V_{CC} = 5\text{V} \pm 5\%$	−0.3	0.6	V
Logic High	With High Trip Level Options	3.6		V
Logic Low	Selected	−0.3	1.2	V
Input Capacitance			7	pF
Hi-Z Input Leakage		−2	+2	$\mu\text{A}$
Output Voltage Levels				
LSTTL Operation	$V_{CC} = 5\text{V} \pm 10\%$			
Logic High ( $V_{OH}$ )	$I_{OH} = -20 \mu\text{A}$	2.7		V
Logic Low ( $V_{OL}$ )	$I_{OL} = 0.36 \text{ mA}$		0.4	V
CMOS Operation				
Logic High	$I_{OH} = -10 \mu\text{A}$	$V_{CC} - 1$		V
Logic Low	$I_{OL} = +10 \mu\text{A}$		0.2	V

Note 1:  $V_{CC}$  voltage change must be less than 0.5V in a 1 ms period to maintain proper operation.

Note 2: SO output "0" level must be less than 0.6V for normal operation.

**COP314L****DC Electrical Characteristics** (Continued)COP314L:  $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ ,  $4.5\text{V} \leq V_{CC} \leq 7.5\text{V}$  unless otherwise noted

Parameter	Conditions	Min	Max	Units
<b>Output Current Levels</b>				
<b>Output Sink Current</b>				
SO and SK Outputs ( $I_{OL}$ )	$V_{CC} = 7.5\text{V}$ , $V_{OL} = 0.4\text{V}$	1.4		mA
	$V_{CC} = 5.5\text{V}$ , $V_{OL} = 0.4\text{V}$	1.0		mA
	$V_{CC} = 4.5\text{V}$ , $V_{OL} = 0.4\text{V}$	0.8		mA
$L_0$ – $L_7$ Outputs, $G_0$ – $G_3$ and LSTTL, $D_0$ – $D_3$ Outputs ( $I_{OL}$ )	$V_{CC} = 7.5\text{V}$ , $V_{OL} = 0.4\text{V}$	0.4		mA
	$V_{CC} = 5.5\text{V}$ , $V_{OL} = 0.4\text{V}$	0.4		mA
	$V_{CC} = 4.5\text{V}$ , $V_{OL} = 0.4\text{V}$	0.4		mA
CKI (Single-pin RC Oscillator) CKO	$V_{CC} = 4.5\text{V}$ , $V_{IH} = 3.5\text{V}$	1.5		mA
	$V_{CC} = 4.5\text{V}$ , $V_{OL} = 0.4\text{V}$	0.2		mA
<b>Output Source Current</b>				
Standard Configuration, All Outputs ( $I_{OH}$ )	$V_{CC} = 7.5\text{V}$ , $V_{OH} = 2.0\text{V}$	–100	–900	$\mu\text{A}$
	$V_{CC} = 5.5\text{V}$ , $V_{OH} = 2.0\text{V}$	–55	–600	$\mu\text{A}$
	$V_{CC} = 4.5\text{V}$ , $V_{OH} = 2.0\text{V}$	–28	–350	$\mu\text{A}$
Push-Pull Configuration SO and SK Outputs ( $I_{OH}$ )	$V_{CC} = 7.5\text{V}$ , $V_{OH} = 3.75\text{V}$	–0.85		mA
	$V_{CC} = 5.5\text{V}$ , $V_{OH} = 2.0\text{V}$	–1.1		mA
	$V_{CC} = 4.5\text{V}$ , $V_{OH} = 1.0\text{V}$	–1.2		mA
Input Load Source Current	$V_{CC} = 5.0\text{V}$ , $V_{IL} = 0\text{V}$	–10	–200	$\mu\text{A}$
Open Drain Output Leakage		–5	+5	$\mu\text{A}$
<b>Total Sink Current Allowed</b>				
All Outputs Combined			100	mA
D Port			100	mA
$L_7$ – $L_4$ , G Port			4	mA
$L_3$ – $L_0$			4	mA
Any Other Pins			1.5	mA
<b>Total Source Current Allowed</b>				
All I/O Combined			120	mA
$L_7$ – $L_4$			60	mA
$L_3$ – $L_0$			60	mA
Each L Pin			25	mA
Any Other Pins			1.5	mA

## AC Electrical Characteristics

COP414L:  $0^{\circ}\text{C} \leq T_A \leq 70^{\circ}\text{C}$ ,  $4.5\text{V} \leq V_{CC} \leq 9.5\text{V}$  unless otherwise noted

COP314L:  $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ ,  $4.5\text{V} \leq V_{CC} \leq 7.5\text{V}$  unless otherwise noted

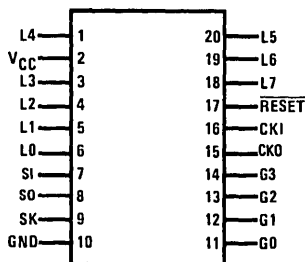
COP214L:  $-40^{\circ}\text{C} \leq T_A \leq +110^{\circ}\text{C}$ ,  $4.5\text{V} \leq V_{CC} \leq 7.5\text{V}$  unless otherwise noted

Parameter	Conditions	Min	Max	Units
Instruction Cycle Time — $t_C$		16	40	$\mu\text{s}$
CKI				
Input Frequency — $f_i$	$\div 8$ Mode	0.2	0.5	MHz
	$\div 4$ Mode	0.1	0.25	MHz
Duty Cycle		30	60	%
Rise Time	$f_i = 0.5$ MHz		500	ns
Fall Time			200	ns
CKI Using RC ( $\div 4$ )	$R = 56\text{ k}\Omega \pm 5\%$ $C = 100\text{ pF} \pm 10\%$			
Instruction Cycle Time (Note 1)		16	28	$\mu\text{s}$
CKO as SYNC Input				
$t_{\text{SYNC}}$		400		ns
Inputs				
$G_3-G_0$ , $L_7-L_0$		8.0		$\mu\text{s}$
$t_{\text{SETUP}}$		1.3		$\mu\text{s}$
$t_{\text{HOLD}}$				
SI		2.0		$\mu\text{s}$
$t_{\text{SETUP}}$		1.0		$\mu\text{s}$
$t_{\text{HOLD}}$				
Output Propagation Delay	Test Condition: $C_L = 50\text{ pF}$ , $R_L = 20\text{ k}\Omega$ , $V_{\text{OUT}} = 1.5\text{V}$			
SO, SK Outputs			4.0	$\mu\text{s}$
$t_{\text{pd1}}$ , $t_{\text{pd0}}$				
All Other Outputs			5.6	$\mu\text{s}$
$t_{\text{pd1}}$ , $t_{\text{pd0}}$				

Note 1: Variation due to the device included.

## Connection Diagram

Dual-In-Line Package



Top View

TL/DD/8814-2

Order Number COP214L-XXX/D,  
COP314L-XXX/D or COP414L-XXX/D  
See NS Hermetic Package D20A

Order Number COP214L-XXX/N,  
COP314L-XXX/N or COP414L-XXX/N  
See NS Molded Package N20A

Order Number COP214L-XXX/WM,  
COP314L-XXX/WM or COP414L-XXX/WM  
See NS Surface Mount Package M20B

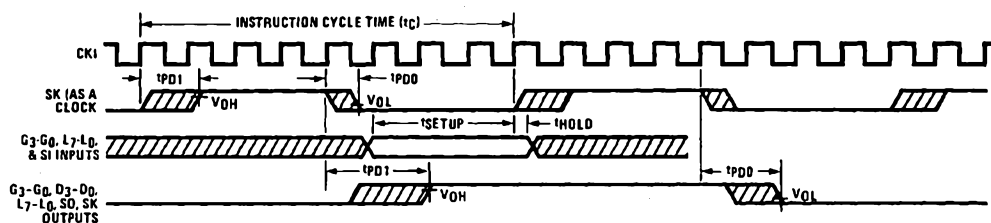
FIGURE 2

## Pin Descriptions

Pin	Description
$L_7-L_0$	8 bidirectional I/O ports with TRI-STATE
$G_3-G_0$	4 bidirectional I/O ports
SI	Serial input (or counter input)
SO	Serial output (or general purpose output)
SK	Logic-controlled clock (or general purpose output)

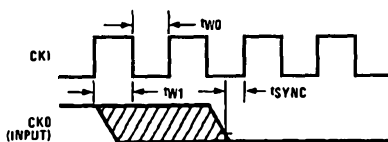
Pin	Description
CKI	System oscillator input
CKO	System oscillator output
RESET	System reset input
$V_{CC}$	Power supply
GND	Ground

## Timing Diagrams



TL/DD/8814-3

FIGURE 3. Input/Output Timing Diagrams (Ceramic Resonator Divide-by-8 Mode)



TL/DD/8814-4

FIGURE 3a. Synchronization Timing

## Functional Description

A block diagram of the COP414L is given in *Figure 1*. Data paths are illustrated in simplified form to depict how the various logic elements communicate with each other in implementing the instruction set of the device. Positive logic is used. When a bit is set, it is a logic "1" (greater than 2V). When a bit is reset, it is a logic "0" (less than 0.8V).

All functional references to the COP414L also apply to the COP314L, and COP214L.

### PROGRAM MEMORY

Program Memory consists of a 512-byte ROM. As can be seen by an examination of the COP414L instruction set, these words may be program instructions, program data or ROM addressing data. Because of the special characteristics associated with the JP, JSRP, JID and LQID instructions, ROM must often be thought of as being organized into 8 pages of 64 words each.

ROM addressing is accomplished by a 9-bit PC register. Its binary value selects one of the 512 8-bit words contained in ROM. A new address is loaded into the PC register during each instruction cycle. Unless the instruction is a transfer of control instruction, the PC register is loaded with the next sequential 9-bit binary count value. Two levels of subroutine nesting are implemented by the 9-bit subroutine save registers, SA and SB, providing a last-in, first-out (LIFO) hardware subroutine stack.

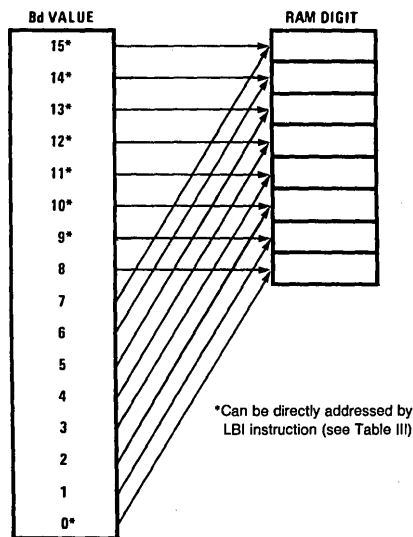
ROM instruction words are fetched, decoded and executed by the Instruction Decode, Control and Skip Logic circuitry.

### DATA MEMORY

Data memory consists of a 128-bit RAM, organized as 4 data registers of 8 4-bit digits. RAM addressing is implemented by a 6-bit B register whose upper 2 bits (Br) select 1 of 4 data registers and lower 3 bits of the 4-bit Bd select 1 of 8 4-bit digits in the selected data register. While the 4-bit contents of the selected RAM digit (M) is usually loaded into or from, or exchanged with, the A register (accumulator), it

may also be loaded into the Q latches or loaded from the L ports. RAM addressing may also be performed directly by the XAD 3,15 instruction.

The most significant bit of Bd is not used to select a RAM digit. Hence each physical digit of RAM may be selected by two different values of Bd as shown in *Figure 4* below. The skip condition for XIS and XDS instructions will be true if Bd changes between 0 and 15, but NOT between 7 and 8 (see Table III).



TL/DD/8814-5

FIGURE 4. RAM Digit Address to Physical RAM Digit Mapping

## Functional Description (Continued)

### INTERNAL LOGIC

The 4-bit A register (accumulator) is the source and destination register for most I/O, arithmetic, logic and data memory access operations. It can also be used to load the Bd portion of the B register, to load 4 bits of the 8-bit Q latch data, to input 4 bits of the 8-bit L I/O port data and to perform data exchanges with the SIO register.

A 4-bit adder performs the arithmetic and logic functions of the COP414L, storing its results in A. It also outputs a carry bit to the 1-bit C register, most often employed to indicate arithmetic overflow. The C register, in conjunction with the XAS instruction and the EN register, also serves to control the SK output. C can be outputted directly to SK or can enable SK to be a sync clock each instruction cycle time. (See XAS instruction and EN register description, below.)

The G register contents are outputs to 4 general-purpose bidirectional I/O ports.

The Q register is an internal, latched, 8-bit register, used to hold data loaded from M and A, as well as 8-bit data from ROM. Its contents are output to the L I/O ports when the L drivers are enabled under program control. (See LEI instruction.)

The 8 L drivers, when enabled, output the contents of latched Q data to the L I/O ports. Also, the contents of L may be read directly into A and M.

The SIO register functions as a 4-bit serial-in serial-out shift register or as a binary counter depending on the contents of the EN register. (See EN register description, below.) Its contents can be exchanged with A, allowing it to input or output a continuous serial data stream. SIO may also be used to provide additional parallel I/O by connecting SO to external serial-in/parallel-out shift registers.

The XAS instruction copies C into the SKL Latch. In the counter mode, SK is the output of SKL in the shift register mode, SK outputs SKL ANDed with internal instruction cycle clock.

The EN register is an internal 4-bit register loaded under program control by the LEI instruction. The state of each bit of this register selects or deselects the particular feature associated with each bit of the EN register ( $EN_3-EN_0$ ).

1. The least significant bit of the enable register,  $EN_0$ , selects the SIO register as either a 4-bit shift register or a 4-bit binary counter. With  $EN_0$  set, SIO is an asynchronous binary counter, *decrementing* its value by one upon

each low-going pulse ("1" to "0") occurring on the SI input. Each pulse must be at least two instruction cycles wide. SK outputs the value of SKL. The SO output is equal to the value of  $EN_3$ . With  $EN_0$  reset, SIO is a serial shift register shifting left each instruction cycle time. The data present at SI goes into the least significant bit of SIO. SO can be enabled to output the most significant bit of SIO each cycle time. (See 4 below.) The SK output becomes a logic-controlled clock.

2.  $EN_1$  is not used. It has no effect on COP414L operation.
3. With  $EN_2$  set, the L drivers are enabled to output the data in Q to the L I/O ports. Resetting  $EN_2$  disables the L drivers, placing the L I/O ports in a high-impedance input state.
4.  $EN_3$ , in conjunction with  $EN_0$ , affects the SO output. With  $EN_0$  set (binary counter option selected) SO will output the value loaded into  $EN_3$ . With  $EN_0$  reset (serial shift register option selected), setting  $EN_3$  enables SO as the output of the SIO shift register, outputting serial shifted data each instruction time. Resetting  $EN_3$  with the serial shift register option selected disables SO as the shift register output; data continues to be shifted through SIO and can be exchanged with A via an XAS instruction but SO remains reset to "0". Table I provides a summary of the modes associated with  $EN_3$  and  $EN_0$ .

### INITIALIZATION

The Reset Logic will initialize (clear) the device upon power-up if the power supply rise time is less than 1 ms and greater than 1  $\mu$ s. If the power supply rise time is greater than 1 ms, the user must provide an external RC network and diode to the RESET pin as shown below (Figure 5). The RESET pin is configured as a Schmitt trigger input. If not used it should be connected to  $V_{CC}$ . Initialization will occur whenever a logic "0" is applied to the RESET input, provided it stays low for at least three instruction cycle times.

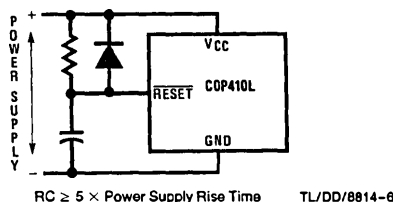


FIGURE 5. Power-Up Clear Circuit

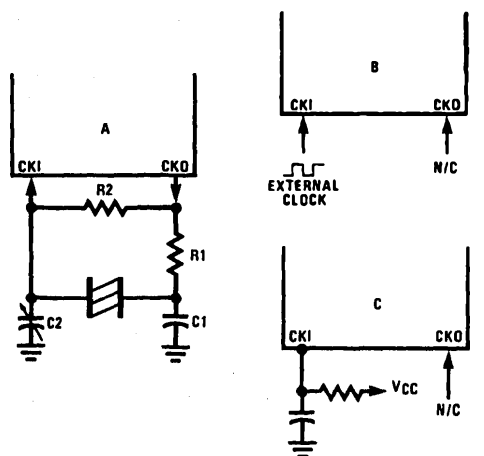
TABLE I. Enable Register Modes—Bits  $EN_3$  and  $EN_0$

$EN_3$	$EN_0$	SIO	SI	SO	SK
0	0	Shift Register	Input to Shift Register	0	If SKL = 1, SK = Clock If SKL = 0, SK = 0
1	0	Shift Register	Input to Shift Register	Serial Out	If SKL = 1, SK = Clock If SKL = 0, SK = 0
0	1	Binary Counter	Input to Binary Counter	0	If SKL = 1, SK = 1 If SKL = 0, SK = 0
1	1	Binary Counter	Input to Binary Counter	1	If SKL = 1, SK = 1 If SKL = 0, SK = 0



## Functional Description (Continued)

Upon initialization, the PC register is cleared to 0 (ROM address 0) and the A, B, C, D, EN and G registers are cleared. The SK output is enabled as a SYNC output, providing a pulse each instruction cycle time. *Data Memory (RAM) is not cleared upon initialization.* The first instruction at address 0 must be a CLRA.



TL/DD/8814-7

**Ceramic Resonator Oscillator**

Resonator Value	Components Values			
	R1 ( $\Omega$ )	R2 ( $\Omega$ )	C1 (pF)	C2 (pF)
455 kHz	4.7k	1M	220	220

**RC Controlled Oscillator**

R (k $\Omega$ )	C (pF)	Instruction Cycle Time in $\mu$ s
51	100	19 $\pm$ 15%
82	56	19 $\pm$ 13%

Note:  $200\text{ k}\Omega \geq R \geq 25\text{ k}\Omega$ ,  $360\text{ pF} \geq C \geq 50\text{ pF}$ . Does not include tolerances.

**FIGURE 6. COP414L Oscillator**

### OSCILLATOR

There are four basic clock oscillator configurations available as shown by Figure 6.

- Resonator Controlled Oscillator.** CKI and CKO are connected to an external ceramic resonator. The instruction cycle frequency equals the resonator frequency divided by 8.
- External Oscillator.** CKI is an external clock input signal. The external frequency is divided by 4 to give the instruction frequency time. CKO is no connection.

- RC Controlled Oscillator.** CKI is configured as a single pin RC controlled Schmitt trigger oscillator. The instruction cycle equals the oscillation frequency divided by 4. CKO is no connection.

### CKO PIN OPTIONS

In a resonator controlled oscillator system, CKO is used as an output to the resonator network. CKO is no connection for External or RC controlled oscillator.

### I/O OPTIONS

COP414L inputs and outputs have the following optional configurations, illustrated in Figure 7:

- Standard**—an enhancement-mode device to ground in conjunction with a depletion-mode device to  $V_{CC}$ , compatible with LSTTL and CMOS input requirements. Available on SO, SK and all D and G outputs.
- Open-Drain**—an enhancement-mode device to ground only, allowing external pull-up as required by the user's application. Available on SO, SK and all D and G outputs.
- Push-Pull**—an enhancement-mode device to ground in conjunction with a depletion-mode device paralleled by an enhancement-mode device to  $V_{CC}$ . This configuration has been provided to allow for fast rise and fall times when driving capacitive loads. Available on SO and SK outputs only.
- Standard L**—same as a., but may be disabled. Available on L outputs only.
- Open Drain L**—same as b., but may be disabled. Available on L outputs only.
- An on-chip depletion load device to  $V_{CC}$ .
- A Hi-Z input which must be driven to a "1" or "0" by external components.

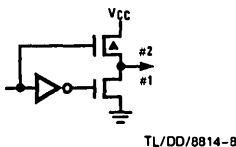
The above input and output configurations share common enhancement-mode and depletion-mode devices. Specifically, all configurations use one or more of six devices (numbered 1–6, respectively). Minimum and maximum current ( $I_{OUT}$  and  $V_{OUT}$ ) curves are given in Figure 8 for each of these devices to allow the designer to effectively use these I/O configurations in designing a COP414L system.

The SO, SK outputs can be configured as shown in a., b., or c. The G outputs can be configured as shown in a. or b. Note that when inputting data to the G ports, the G outputs should be set to "1". The L outputs can be configured as in d., or e.

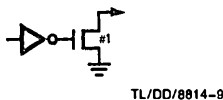
An important point to remember if using configuration d. with the L drivers is that even when the L drivers are disabled, the depletion load device will source a small amount of current. (See Figure 8, device 2.) However, when the L port is used as input, the disabled depletion device CAN NOT be relied on to source sufficient current to pull an input to a logic "1".

## Functional Description (Continued)

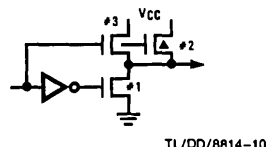
a. Standard Output



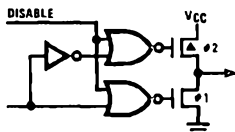
b. Open-Drain Output



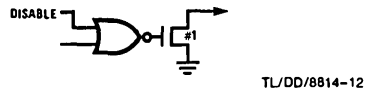
c. Push-Pull Output



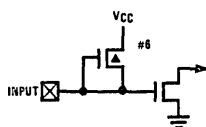
d. Standard L Output



e. Open-Drain L Output



f. Input with Load



g. Hi-Z Input

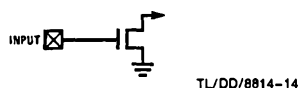


FIGURE 7. Input and Output Configurations

## Typical Performance Curves

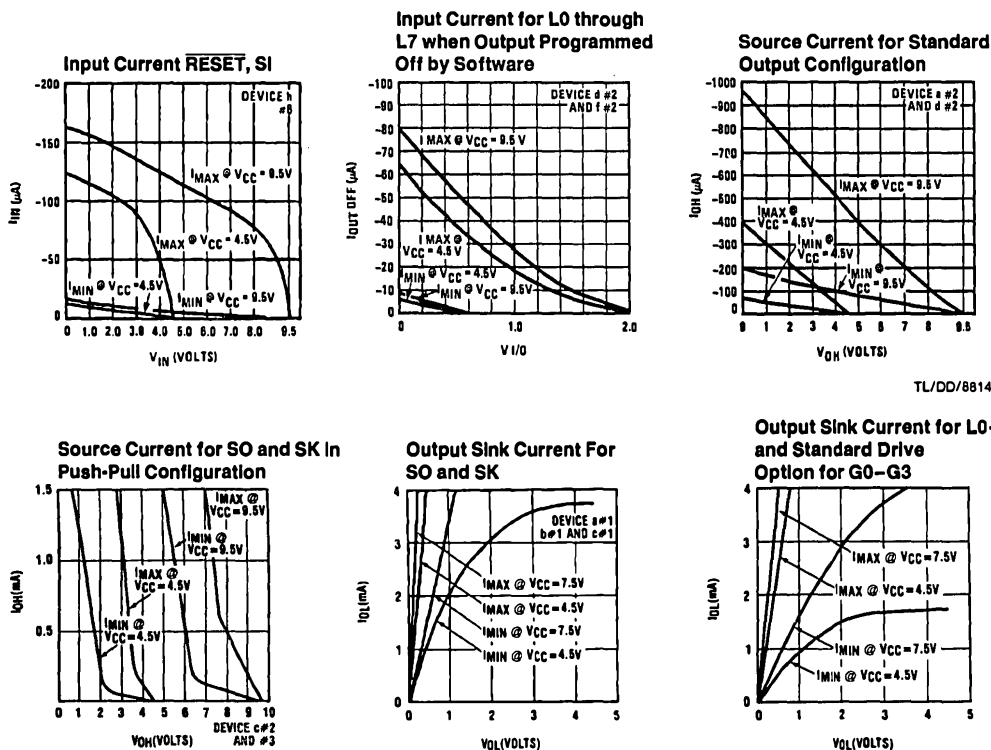


FIGURE 8a. COP414 I/O DC Current Characteristics

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# Typical Performance Curves (Continued)

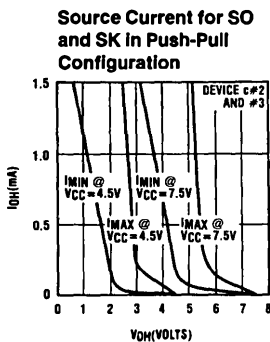
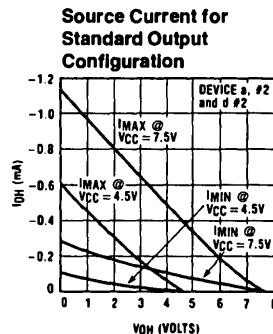
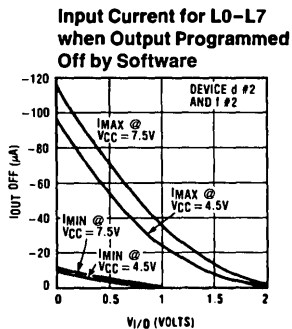
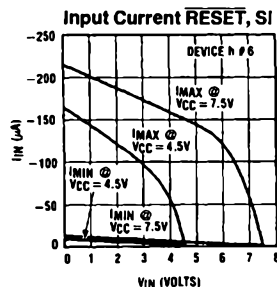


FIGURE 8b. COP314L Input/Output Characteristics

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## COP414L Instruction Set

Table II is a symbol table providing internal architecture, instruction operand and operational symbols used in the instruction set table.

Table III provides the mnemonic, operand, machine code, data flow, skip conditions and description associated with each instruction in the COP414L instruction set.

TABLE II. COP414L Instruction Set Table Symbols

Symbol	Definition	Symbol	Definition
<b>INTERNAL ARCHITECTURE SYMBOLS</b>		<b>INSTRUCTION OPERAND SYMBOLS</b>	
A	4-bit Accumulator	d	4-bit Operand Field, 0–15 binary (RAM Digit Select)
B	6-bit RAM Address Register	r	2-bit Operand Field, 0–3 binary (RAM Register Select)
Br	Upper 2 bits of B (register address)	a	9-bit Operand Field, 0–511 binary (ROM Address)
Bd	Lower 4 bits of B (digit address)	y	4-bit Operand Field, 0–15 binary (Immediate Data)
C	1-bit Carry Register	RAM(s)	Contents of RAM location addressed by s
D	4-bit Data Output Port	ROM(t)	Contents of ROM location addressed by t
EN	4-bit Enable Register	<b>OPERATIONAL SYMBOLS</b>	
G	4-bit Register to latch data for G I/O Port	+	Plus
L	8-bit TRI-STATE I/O Port	–	Minus
M	4-bit contents of RAM Memory pointed to by B Register	→	Replaces
PC	9-bit ROM Address Register (program counter)	↔	Is exchanged with
Q	8-bit Register to latch data for L I/O Port	=	Is equal to
SA	9-bit Subroutine Save Register A	$\bar{A}$	The one's complement of A
SB	9-bit Subroutine Save Register B	⊕	Exclusive-OR
SIO	4-bit Shift Register and Counter	:	Range of values
SK	Logic-Controlled Clock Output		

TABLE III. COP414L Instruction Set

Mnemonic	Operand	Hex Code	Machine Language Code (Binary)	Data Flow	Skip Conditions	Description
<b>ARITHMETIC INSTRUCTIONS</b>						
ASC		30	0011 0000	$A + C + \text{RAM}(B) \rightarrow A$ Carry $\rightarrow C$	Carry	Add with Carry, Skip on Carry
ADD		31	0011 0001	$A + \text{RAM}(B) \rightarrow A$	None	Add RAM to A
AISC	y	5–	0101  y	$A + y \rightarrow A$	Carry	Add Immediate, Skip on Carry ( $y \neq 0$ )
CLRA		00	0000 0000	$0 \rightarrow A$	None	Clear A
COMP		40	0100 0000	$\bar{A} \rightarrow A$	None	One's complement of A to A
NOP		44	0100 0100	None	None	No Operation
RC		32	0011 0010	"0" $\rightarrow C$	None	Reset C
SC		22	0010 0010	"1" $\rightarrow C$	None	Set C
XOR		02	0000 0010	$A \oplus \text{RAM}(B) \rightarrow A$	None	Exclusive-OR RAM with A

**COP414L Instruction Set** (Continued)**TABLE III. COP414L Instruction Set** (Continued)

Mnemonic	Operand	Hex Code	Machine Language Code (Binary)	Data Flow	Skip Conditions	Description
<b>TRANSFER OF CONTROL INSTRUCTIONS</b>						
JID		FF	<u>1111</u> <u>1111</u>	ROM (PC <sub>8,A,M</sub> ) PC <sub>7:0</sub>	None	Jump Indirect (Note 2)
JMP	a	6--	<u>0110</u> <u>000</u> <u>a<sub>8</sub></u> a <sub>7:0</sub>	a → PC	None	Jump
JP	a	--	<u>1</u> a <sub>6:0</sub> (pages 2, 3 only) or <u>11</u> a <sub>5:0</sub> (all other pages)	a → PC <sub>6:0</sub> a → PC <sub>5:0</sub>	None	Jump within Page (Note 3)
JSRP	a	--	<u>10</u> a <sub>5:0</sub>	PC + 1 → SA → SB 010 → PC <sub>8:6</sub> a → PC <sub>5:0</sub>	None	Jump to Subroutine Page (Note 4)
JSR	a	6--	<u>0110</u> <u>100</u> <u>a<sub>8</sub></u> a <sub>7:0</sub>	PC + 1 → SA → SB a → PC	None	Jump to Subroutine
RET		48	<u>0100</u> <u>1000</u>	SB → SA → PC	None	Return from Subroutine
RETSK		49	<u>0100</u> <u>1001</u>	SB → SA → PC	Always Skip on Return	Return from Subroutine then Skip
<b>MEMORY REFERENCE INSTRUCTIONS</b>						
CAMQ		33 3C	<u>0011</u> <u>0011</u> <u>0011</u> <u>1100</u>	A → Q <sub>7:4</sub> RAM(B) → Q <sub>3:0</sub>	None	Copy A, RAM to Q
LD	r	-5	<u>00</u> <u>r</u> <u>0101</u>	RAM(B) → A Br ⊕ r → Br	None	Load RAM into A, Exclusive-OR Br with r
LQID		BF	<u>1011</u> <u>1111</u>	ROM(PC <sub>8, A, M</sub> ) → Q SA → SB	None	Load Q Indirect (Note 2)
RMB	0 1 2 3	4C 45 42 43	<u>0100</u> <u>1100</u> <u>0100</u> <u>0101</u> <u>0100</u> <u>0010</u> <u>0100</u> <u>0011</u>	0 → RAM(B) <sub>0</sub> 0 → RAM(B) <sub>1</sub> 0 → RAM(B) <sub>2</sub> 0 → RAM(B) <sub>3</sub>	None	Reset RAM Bit
SMB	0 1 2 3	4D 47 46 4B	<u>0100</u> <u>1101</u> <u>0100</u> <u>0111</u> <u>0100</u> <u>0110</u> <u>0100</u> <u>1011</u>	1 → RAM(B) <sub>0</sub> 1 → RAM(B) <sub>1</sub> 1 → RAM(B) <sub>2</sub> 1 → RAM(B) <sub>3</sub>	None	Set RAM Bit
STII	y	7-	<u>0111</u> y	y → RAM(B) Bd + 1 → Bd	None	Store Memory Immediate and Increment Bd
X	r	-6	<u>00</u> <u>r</u> <u>0110</u>	RAM(B) ↔ A Br ⊕ r → Br	None	Exchange RAM with A, Exclusive-OR Br with r
XAD	3, 15	23 BF	<u>0010</u> <u>0011</u> <u>1011</u> <u>1111</u>	RAM(3,15) ↔ A	None	Exchange A with RAM (3,15)
XDS	r	-7	<u>00</u> <u>r</u> <u>0111</u>	RAM(B) ↔ A Bd - 1 → Bd Br ⊕ r → Br	Bd decrements past 0	Exchange RAM with A and Decrement Bd, Exclusive-OR Br with r
XIS	r	-4	<u>00</u> <u>r</u> <u>0100</u>	RAM(B) ↔ A Bd + 1 → Bd Br ⊕ r → Br	Bd increments past 15	Exchange RAM with A and Increment Bd Exclusive-OR Br with r

**COP414L Instruction Set** (Continued)**TABLE III. COP414L Instruction Set** (Continued)

Mnemonic	Operand	Hex Code	Machine Language Code (Binary)	Data Flow	Skip Conditions	Description
REGISTER REFERENCE INSTRUCTIONS						
CAB		50	0101 0000	A → Bd	None	Copy A to Bd
CBA		4E	0100 1110	Bd → A	None	Copy Bd to A
LBi	r,d	--	00   r   (d - 1) (d = 0,9:15)	r,d → B	Skip until not a LBi	Load B Immediate with r,d (Note 5)
LEI	y	33 6-	0011 0011 0010   y	y → EN	None	Load EN Immediate (Note 6)
TEST INSTRUCTIONS						
SKC		20	0010 0000		C = "1"	Skip if C is True
SKE		21	0010 0001		A = RAM(B)	Skip if A Equals RAM
SKGZ		33 21	0011 0011 0010 0001		G <sub>3:0</sub> = 0	Skip if G is Zero (all 4 bits)
SKGBZ		33	0011 0011	1st byte 2nd byte		Skip if G Bit is Zero
	0	01	0000 0001		G <sub>0</sub> = 0	
	1	11	0001 0001		G <sub>1</sub> = 0	
	2	03	0000 0011		G <sub>2</sub> = 0	
	3	13	0001 0011		G <sub>3</sub> = 0	
SKMBZ	0	01	0000 0001		RAM(B) <sub>0</sub> = 0	Skip if RAM Bit is Zero
	1	11	0001 0001		RAM(B) <sub>1</sub> = 0	
	2	03	0000 0011		RAM(B) <sub>2</sub> = 0	
	3	13	0001 0011		RAM(B) <sub>3</sub> = 0	
INPUT/OUTPUT INSTRUCTIONS						
ING		33 2A	0011 0011 0010 1010	G → A	None	Input G Ports to A
INL		33 2E	0011 0011 0010 1110	L <sub>7:4</sub> → RAM(B) L <sub>3:0</sub> → A	None	Input L Ports to RAM, A
OBD		33 3E	0011 0011 0011 1110	Bd → D	None	Output Bd to D Outputs
OMG		33 3A	0011 0011 0011 1010	RAM(B) → G	None	Output RAM to G Ports
XAS		4F	0100 1111	A ↔ SIO, C → SKL	None	Exchange A with SIO (Note 2)

**Note 1:** All subscripts for alphabetical symbols indicate bit numbers unless explicitly defined (e.g., Br and Bd are explicitly defined). Bits are numbered 0 to N where 0 signifies the least significant bit (low-order, right-most bit). For example, A<sub>3</sub> indicates the most significant (left-most) bit of the 4-bit A register.

**Note 2:** For additional information on the operation of the XAS, JID, and LQID instructions, see below.

**Note 3:** The JP instruction allows a jump, while in subroutine pages 2 or 3, to any ROM location within the two-page boundary of pages 2 or 3. The JP instruction, otherwise, permits a jump to a ROM location within the current 64-word page. JP may not jump to the last word of a page.

**Note 4:** A JSRP transfers program control to subroutine page 2 (0010 is loaded into the upper 4 bits of P). A JSRP may not be used when in pages 2 or 3. JSRP may not jump to the last word in page 2.

**Note 5:** The machine code for the lower 4 bits of the LBi instruction equals the binary value of the "d" data *minus 1*, e.g., to load the lower four bits of B (Bd) with the value 9 (1001<sub>2</sub>), the lower 4 bits of the LBi instruction equal 8 (1000<sub>2</sub>). To load 0, the lower 4 bits of the LBi instruction should equal 15 (1111<sub>2</sub>).

**Note 6:** Machine code for operand field y for LEI instruction should equal the binary value to be latched into EN, where a "1" or "0" in each bit of EN corresponds with the selection or deselection of a particular function associated with each bit. (See Functional Description, EN Register.)

## Option List

The COP414L mask-programmable options are assigned numbers which correspond with the COP414L pins.

The following is a list of COP414L options. The options are programmed at the same time as the ROM pattern to provide the user with the hardware flexibility to interface to various I/O components using little or no external circuitry.

### Option 1: L<sub>4</sub> Driver

- = 0: Standard output
- = 1: Open-drain output

### Option 2: V<sub>CC</sub> Pin

- = 0: Standard V<sub>CC</sub>
- = 1: Optional higher voltage V<sub>CC</sub>

### Option 3: L<sub>3</sub> Driver

same as Option 1

### Option 4: L<sub>2</sub> Driver

same as Option 1

### Option 5: L<sub>1</sub> Driver

same as Option 1

### Option 6: L<sub>6</sub> Driver

same as Option 1

### Option 7: SI Input

- = 0: load device to V<sub>CC</sub>
- = 1: Hi-Z Output

### Option 8: SO Driver

- = 0: Standard output
- = 1: Open-drain output
- = 2: Push-pull output

### Option 9: SK Driver

same as Option 8

### Option 10:

- = 0: Ground Pin—no options available

### Option 11: G<sub>0</sub> I/O Port

- = 0: Standard output
- = 1: Open-drain output

### Option 12: G<sub>1</sub> I/O Port

same as Option 11

### Option 13: G<sub>2</sub> I/O Port

same as Option 11

### Option 14: G<sub>3</sub> I/O Port

same as Option 11

### Option 15: CKO Output

- = 0: Clock output to ceramic resonator/crystal
- = 1: No connection

### Option 16: CKI Input

- = 0: Oscillator input divided by 8 (500 kHz max)
- = 1: Single pin RC controlled oscillator divided by 4
- = 2: External Schmitt trigger level clock divided by 4

### Option 17: RESET Input

- = 0: Load device to V<sub>CC</sub>
- = 1: Hi-Z Input

### Option 18: L<sub>7</sub> Driver

same as Option 1

### Option 19: L<sub>6</sub> Driver

same as Option 1

### Option 20: L<sub>6</sub> Driver

same as Option 1

### Option 21: L Input Levels

- = 0: Standard TTL input levels ("0" = 0.8V, "1" = 2.0V)
- = 1: Higher voltage input levels ("0" = 1.2V, "1" = 3.6V)

### Option 22: G Input Levels

same as Option 21

### Option 23: SI Input Levels

same as Option 21

## TEST MODE (NON-STANDARD OPERATION)

The SO output has been configured to provide for standard test procedures for the custom-programmed COP414L. With SO forced to logic "1", two test modes are provided, depending upon the value of SI:

- a. RAM and Internal Logic Test Mode (SI = 1)
- b. ROM Test Mode (SI = 0)

These special test modes should not be employed by the user; they are intended for manufacturing tests only.

## COP414L Option List

Please fill out the Option List and send it with the EPROM.

### Option Data

- OPTION 1 VALUE = \_\_\_\_\_ IS: L<sub>4</sub> DRIVER
- OPTION 2 VALUE = \_\_\_\_\_ IS: V<sub>CC</sub> PIN
- OPTION 3 VALUE = \_\_\_\_\_ IS: L<sub>3</sub> DRIVER
- OPTION 4 VALUE = \_\_\_\_\_ IS: L<sub>2</sub> DRIVER
- OPTION 5 VALUE = \_\_\_\_\_ IS: L<sub>1</sub> DRIVER
- OPTION 6 VALUE = \_\_\_\_\_ IS: L<sub>6</sub> DRIVER
- OPTION 7 VALUE = \_\_\_\_\_ IS: SI INPUT
- OPTION 8 VALUE = \_\_\_\_\_ IS: SO DRIVER
- OPTION 9 VALUE = \_\_\_\_\_ IS: SK DRIVER
- OPTION 10 VALUE = 0 IS: GROUND PIN
- OPTION 11 VALUE = \_\_\_\_\_ IS: G<sub>0</sub> I/O PORT
- OPTION 12 VALUE = \_\_\_\_\_ IS: G<sub>1</sub> I/O PORT
- OPTION 13 VALUE = \_\_\_\_\_ IS: G<sub>2</sub> I/O PORT
- OPTION 14 VALUE = \_\_\_\_\_ IS: G<sub>3</sub> I/O PORT
- OPTION 15 VALUE = \_\_\_\_\_ IS: CKO OUTPUT
- OPTION 16 VALUE = \_\_\_\_\_ IS: CKI INPUT
- OPTION 17 VALUE = \_\_\_\_\_ IS: RESET INPUT
- OPTION 18 VALUE = \_\_\_\_\_ IS: L<sub>7</sub> DRIVER
- OPTION 19 VALUE = \_\_\_\_\_ IS: L<sub>6</sub> DRIVER
- OPTION 20 VALUE = \_\_\_\_\_ IS: L<sub>6</sub> DRIVER
- OPTION 21 VALUE = \_\_\_\_\_ IS: L INPUT LEVELS
- OPTION 22 VALUE = \_\_\_\_\_ IS: G INPUT LEVELS
- OPTION 23 VALUE = \_\_\_\_\_ IS: SI INPUT LEVELS